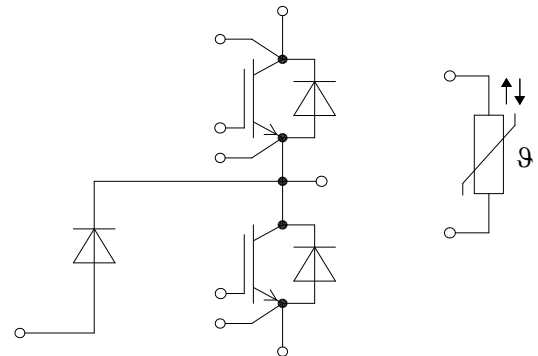
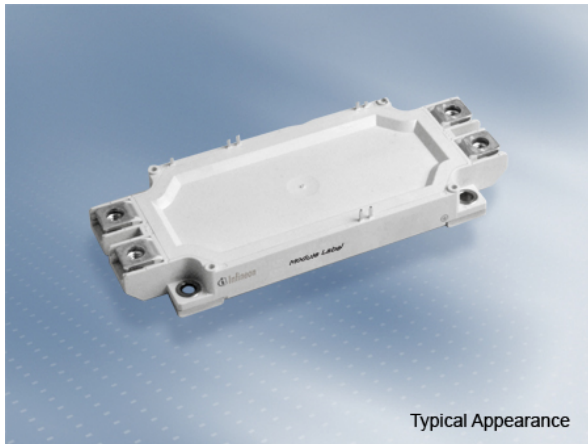


EconoDUAL™3 Modul mit Trench/Feldstopp IGBT4 und Emitter Controlled HE Diode und NTC / bereits aufgetragenem Thermal Interface Material

EconoDUAL™3 module with Trench/Fieldstop IGBT4 and Emitter Controlled HE diode and NTC / pre-applied Thermal Interface Material



$$V_{CES} = 1200V$$

$$I_{C\,nom} = 300A / I_{CRM} = 600A$$

## Potentielle Anwendungen

- 3-Level-Applikationen

## Elektrische Eigenschaften

- Erweiterte Sperrschichttemperatur  $T_{vj\,op}$
- Niedrige Schaltverluste
- Niedriges  $V_{CESat}$
- Sehr große Robustheit
- $T_{vj\,op} = 150^{\circ}C$
- $V_{CESat}$  mit positivem Temperaturkoeffizienten

## Mechanische Eigenschaften

- Isolierte Bodenplatte
- Standardgehäuse
- Thermisches Interface Material bereits aufgetragen

## Potential Applications

- 3-level-applications

## Electrical Features

- Extended operating temperature  $T_{vj\,op}$
- Low switching losses
- Low  $V_{CESat}$
- Unbeatable robustness
- $T_{vj\,op} = 150^{\circ}C$
- $V_{CESat}$  with positive temperature coefficient

## Mechanical Features

- Isolated base plate
- Standard housing
- Pre-applied Thermal Interface Material

## Module Label Code

Barcode Code 128



DMX - Code



## Content of the Code

| Content of the Code        | Digit   |
|----------------------------|---------|
| Module Serial Number       | 1 - 5   |
| Module Material Number     | 6 - 11  |
| Production Order Number    | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

**IGBT, Wechselrichter / IGBT, Inverter****Höchstzulässige Werte / Maximum Rated Values**

|                                                                          |                                                                        |                    |       |   |
|--------------------------------------------------------------------------|------------------------------------------------------------------------|--------------------|-------|---|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$                                          | $V_{CES}$          | 1200  | V |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_H = 90^{\circ}\text{C}$ , $T_{vj\text{ max}} = 175^{\circ}\text{C}$ | $I_{C\text{ nom}}$ | 300   | A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\text{ ms}$                                                    | $I_{CRM}$          | 600   | A |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |                                                                        | $V_{GES}$          | +/-20 | V |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                                                                                          |                                                                                                                           | min.                | typ.                 | max.  |                                                 |
|----------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------|---------------------|----------------------|-------|-------------------------------------------------|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage     | $I_C = 300\text{ A}$ , $V_{GE} = 15\text{ V}$<br>$I_C = 300\text{ A}$ , $V_{GE} = 15\text{ V}$<br>$I_C = 300\text{ A}$ , $V_{GE} = 15\text{ V}$                                                          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $V_{CE\text{ sat}}$ | 1,75<br>2,00<br>2,05 | 2,10  | V<br>V<br>V                                     |
| Gate-Schwellenspannung<br>Gate threshold voltage                                 | $I_C = 11,5\text{ mA}$ , $V_{CE} = V_{GE}$ , $T_{vj} = 25^{\circ}\text{C}$                                                                                                                               |                                                                                                                           | $V_{GEth}$          | 5,20                 | 5,80  | 6,40 V                                          |
| Gateladung<br>Gate charge                                                        | $V_{GE} = -15\text{ V} \dots +15\text{ V}$                                                                                                                                                               |                                                                                                                           | $Q_G$               | 2,25                 |       | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                                | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                            |                                                                                                                           | $R_{Gint}$          | 2,5                  |       | $\Omega$                                        |
| Eingangskapazität<br>Input capacitance                                           | $f = 1\text{ MHz}$ , $T_{vj} = 25^{\circ}\text{C}$ , $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$                                                                                                      |                                                                                                                           | $C_{ies}$           | 19,0                 |       | nF                                              |
| Rückwirkungskapazität<br>Reverse transfer capacitance                            | $f = 1\text{ MHz}$ , $T_{vj} = 25^{\circ}\text{C}$ , $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$                                                                                                      |                                                                                                                           | $C_{res}$           | 1,05                 |       | nF                                              |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                 | $V_{CE} = 1200\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$                                                                                                                         |                                                                                                                           | $I_{CES}$           |                      | 1,0   | mA                                              |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                           | $V_{CE} = 0\text{ V}$ , $V_{GE} = 20\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$                                                                                                                           |                                                                                                                           | $I_{GES}$           |                      | 100   | nA                                              |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load  | $I_C = 300\text{ A}$ , $V_{CE} = 600\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Gon} = 1,0\ \Omega$                                                                                                  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $t_{d\text{ on}}$   | 0,18<br>0,20<br>0,21 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                        | $I_C = 300\text{ A}$ , $V_{CE} = 600\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Gon} = 1,0\ \Omega$                                                                                                  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $t_r$               | 0,05<br>0,06<br>0,06 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load  | $I_C = 300\text{ A}$ , $V_{CE} = 600\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Goff} = 1,0\ \Omega$                                                                                                 | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $t_{d\text{ off}}$  | 0,38<br>0,48<br>0,51 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                            | $I_C = 300\text{ A}$ , $V_{CE} = 600\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Goff} = 1,0\ \Omega$                                                                                                 | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $t_f$               | 0,05<br>0,08<br>0,09 |       | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse                | $I_C = 300\text{ A}$ , $V_{CE} = 600\text{ V}$ , $L_S = 35\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}$ , $di/dt = 4650\text{ A}/\mu\text{s}$ ( $T_{vj} = 150^{\circ}\text{C}$ )<br>$R_{Gon} = 1,0\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $E_{on}$            | 18,0<br>27,5<br>30,5 |       | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse                | $I_C = 300\text{ A}$ , $V_{CE} = 600\text{ V}$ , $L_S = 35\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}$ , $du/dt = 3500\text{ V}/\mu\text{s}$ ( $T_{vj} = 150^{\circ}\text{C}$ )<br>$R_{Goff} = 1,0\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                         | $E_{off}$           | 17,5<br>28,0<br>31,5 |       | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data                                                   | $V_{GE} \leq 15\text{ V}$ , $V_{CC} = 800\text{ V}$<br>$V_{CE\text{ max}} = V_{CES} - L_{SCE} \cdot di/dt$                                                                                               | $t_P \leq 10\ \mu\text{s}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$t_P \leq 10\ \mu\text{s}$ , $T_{vj} = 150^{\circ}\text{C}$ | $I_{SC}$            | 1900<br>1400         |       | A<br>A                                          |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro IGBT / per IGBT<br>valid with IFX pre-applied thermal interface material                                                                                                                             |                                                                                                                           | $R_{thJH}$          |                      | 0,105 | K/W                                             |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                                                                                          |                                                                                                                           | $T_{vj\text{ op}}$  | -40                  | 150   | $^{\circ}\text{C}$                              |

**Diode, Wechselrichter / Diode, Inverter****Höchstzulässige Werte / Maximum Rated Values**

|                                                                     |                                                                                                                                              |           |                |                                              |
|---------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|-----------|----------------|----------------------------------------------|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                | $V_{RRM}$ | 1200           | V                                            |
| Dauergleichstrom<br>Continuous DC forward current                   |                                                                                                                                              | $I_F$     | 300            | A                                            |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_P = 1\text{ ms}$                                                                                                                          | $I_{FRM}$ | 600            | A                                            |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 19000<br>15500 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                            |                                                                                                   | min.               | typ. | max.                 |                                                 |
|----------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|--------------------|------|----------------------|-------------------------------------------------|
| Durchlassspannung<br>Forward voltage                                             | $I_F = 300\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 300\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 300\text{ A}, V_{GE} = 0\text{ V}$        | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$              |      | 1,65<br>1,65<br>1,65 | 2,15<br>V<br>V<br>V                             |
| Rückstromspitze<br>Peak reverse recovery current                                 | $I_F = 300\text{ A}, -di_F/dt = 4650\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 600\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$           |      | 335<br>400<br>420    | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                      | $I_F = 300\text{ A}, -di_F/dt = 4650\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 600\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$              |      | 32,0<br>60,0<br>69,0 | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                              | $I_F = 300\text{ A}, -di_F/dt = 4650\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 600\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$          |      | 16,0<br>30,0<br>34,0 | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro Diode / per diode<br>valid with IFX pre-applied thermal interface material                                                             |                                                                                                   | $R_{thJH}$         |      |                      | 0,133 K/W                                       |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                            |                                                                                                   | $T_{vj\text{ op}}$ | -40  |                      | 150 $^{\circ}\text{C}$                          |

**Diode, 3-Level / Diode, 3-Level****Höchstzulässige Werte / Maximum Rated Values**

|                                                                     |                                                                                                                                              |           |                |                                              |
|---------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|-----------|----------------|----------------------------------------------|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                | $V_{RRM}$ | 1200           | V                                            |
| Dauergleichstrom<br>Continuous DC forward current                   |                                                                                                                                              | $I_F$     | 300            | A                                            |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_P = 1\text{ ms}$                                                                                                                          | $I_{FRM}$ | 600            | A                                            |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 19000<br>15500 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|                                                                                  |                                                                                                                                     |                                                                                                   | min.               | typ. | max.                 |                                                 |
|----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|--------------------|------|----------------------|-------------------------------------------------|
| Durchlassspannung<br>Forward voltage                                             | $I_F = 300\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 300\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 300\text{ A}, V_{GE} = 0\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$              |      | 1,65<br>1,65<br>1,65 | 2,15<br>V<br>V<br>V                             |
| Rückstromspitze<br>Peak reverse recovery current                                 | $I_F = 300\text{ A}, -di_F/dt = 4650\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 600\text{ V}$                     | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$           |      | 335<br>400<br>420    | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                      | $I_F = 300\text{ A}, -di_F/dt = 4650\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 600\text{ V}$                     | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$              |      | 32,0<br>60,0<br>69,0 | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                              | $I_F = 300\text{ A}, -di_F/dt = 4650\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 600\text{ V}$                     | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$          |      | 16,0<br>30,0<br>34,0 | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Kühlkörper<br>Thermal resistance, junction to heatsink | pro Diode / per diode<br>valid with IFX pre-applied thermal interface material                                                      |                                                                                                   | $R_{thJH}$         |      |                      | 0,133 K/W                                       |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions            |                                                                                                                                     |                                                                                                   | $T_{vj\text{ op}}$ | -40  |                      | 150 $^{\circ}\text{C}$                          |

**NTC-Widerstand / NTC-Thermistor****Charakteristische Werte / Characteristic Values**

|                                          |                                                                |              | min. | typ. | max. |            |
|------------------------------------------|----------------------------------------------------------------|--------------|------|------|------|------------|
| Nennwiderstand<br>Rated resistance       | $T_{NTC} = 25^{\circ}\text{C}$                                 | $R_{25}$     |      | 5,00 |      | k $\Omega$ |
| Abweichung von R100<br>Deviation of R100 | $T_{NTC} = 100^{\circ}\text{C}, R_{100} = 493 \Omega$          | $\Delta R/R$ | -5   |      | 5    | %          |
| Verlustleistung<br>Power dissipation     | $T_{NTC} = 25^{\circ}\text{C}$                                 | $P_{25}$     |      |      | 20,0 | mW         |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/50}$  |      | 3375 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/80}$  |      | 3411 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ | $B_{25/100}$ |      | 3433 |      | K          |

Angaben gemäß gültiger Application Note.

Specification according to the valid application note.

**Modul / Module**

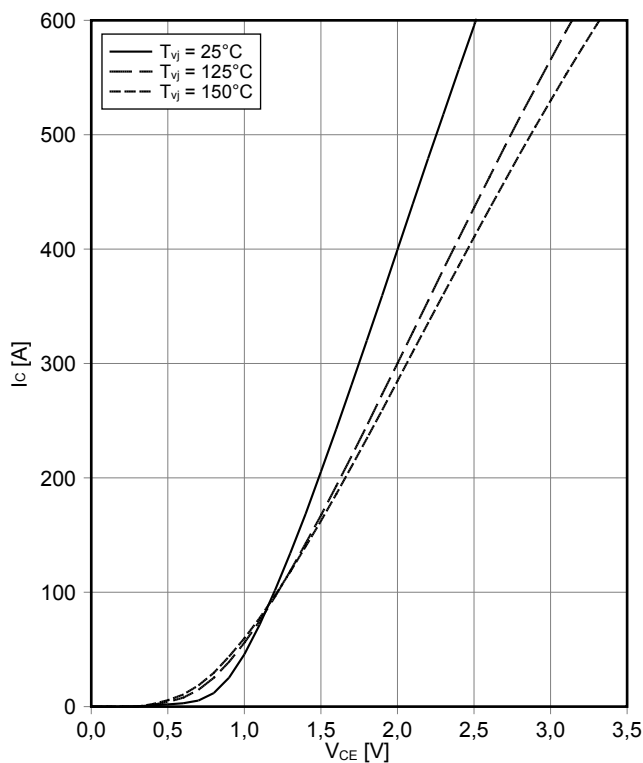
|                                                                                              |                                                                                                                    |              |      |                                |      |                    |
|----------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------|--------------|------|--------------------------------|------|--------------------|
| Isolations-Prüfspannung<br>Isolation test voltage                                            | RMS, f = 50 Hz, t = 1 min                                                                                          | $V_{ISOL}$   |      | 2,5                            |      | kV                 |
| Material Modulgrundplatte<br>Material of module baseplate                                    |                                                                                                                    |              |      | Cu                             |      |                    |
| Innere Isolation<br>Internal isolation                                                       | Basisisolierung (Schutzklasse 1, EN61140)<br>basic insulation (class 1, IEC 61140)                                 |              |      | Al <sub>2</sub> O <sub>3</sub> |      |                    |
| Kriechstrecke<br>Creepage distance                                                           | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal                            |              |      | 14,5<br>13,0                   |      | mm                 |
| Luftstrecke<br>Clearance                                                                     | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal                            |              |      | 12,5<br>10,0                   |      | mm                 |
| Vergleichszahl der Kriechwegbildung<br>Comperative tracking index                            |                                                                                                                    | CTI          |      | > 200                          |      |                    |
|                                                                                              |                                                                                                                    |              |      |                                |      |                    |
|                                                                                              |                                                                                                                    |              | min. | typ.                           | max. |                    |
| Modulstreuinduktivität<br>Stray inductance module                                            |                                                                                                                    | $L_{sCE}$    |      | 35                             |      | nH                 |
| Modulleitungswiderstand, Anschlüsse - Chip<br>Module lead resistance, terminals - chip       | $T_H = 25^{\circ}\text{C}$ , pro Schalter / per switch                                                             | $R_{CC+EE'}$ |      | 1,45                           |      | m $\Omega$         |
| Lagertemperatur<br>Storage temperature                                                       |                                                                                                                    | $T_{stg}$    | -40  |                                | 125  | $^{\circ}\text{C}$ |
| Höchstzulässige<br>Bodenplattenbetriebstemperatur<br>Maximum baseplate operation temperature |                                                                                                                    | $T_{BPmax}$  |      |                                | 125  | $^{\circ}\text{C}$ |
| Anzugsdrehmoment f. Modulmontage<br>Mounting torque for modul mounting                       | Schraube M5 - Montage gem. gültiger Applikationsschrift<br>Screw M5 - Mounting according to valid application note | M            | 3,00 |                                | 6,00 | Nm                 |
| Anzugsdrehmoment f. elektr. Anschlüsse<br>Terminal connection torque                         | Schraube M6 - Montage gem. gültiger Applikationsschrift<br>Screw M6 - Mounting according to valid application note | M            | 3,0  | -                              | 6,0  | Nm                 |
| Gewicht<br>Weight                                                                            |                                                                                                                    | G            |      | 345                            |      | g                  |

Lagerung und Transport von Modulen mit TIM =&gt; siehe AN2012-07

Storage and shipment of modules with TIM =&gt; see AN2012-07

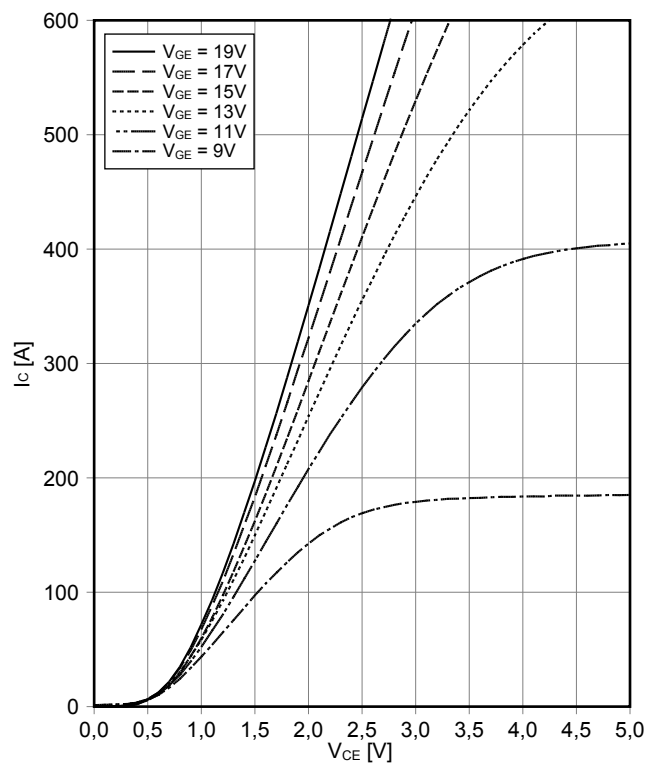
**Ausgangskennlinie IGBT, Wechselrichter (typisch)**  
**output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15 \text{ V}$



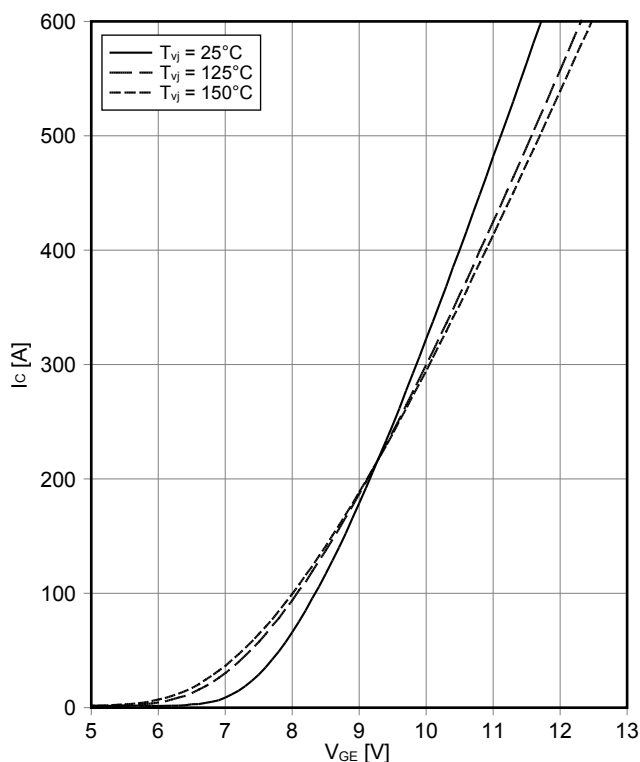
**Ausgangskennlinienfeld IGBT, Wechselrichter (typisch)**  
**output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



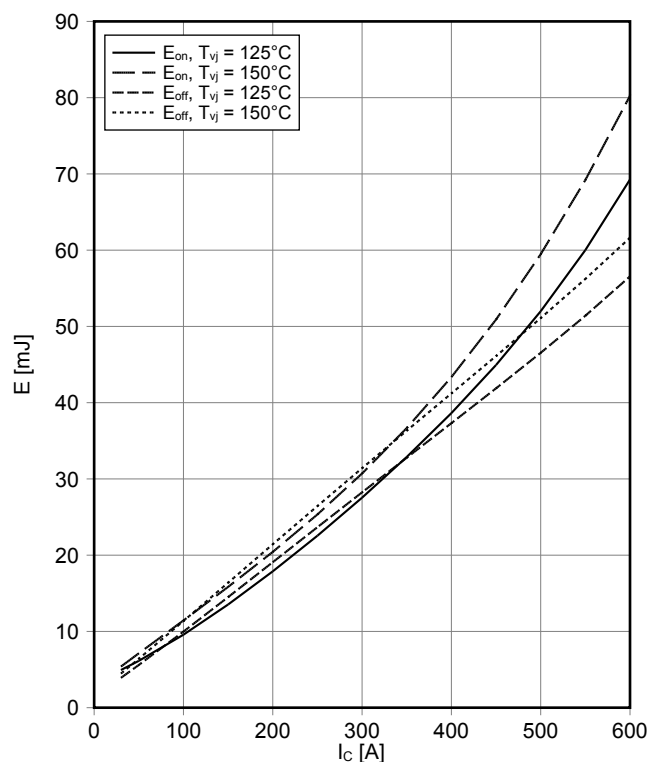
**Übertragungscharakteristik IGBT, Wechselrichter (typisch)**  
**transfer characteristic IGBT, Inverter (typical)**

$I_C = f(V_{GE})$   
 $V_{CE} = 20 \text{ V}$



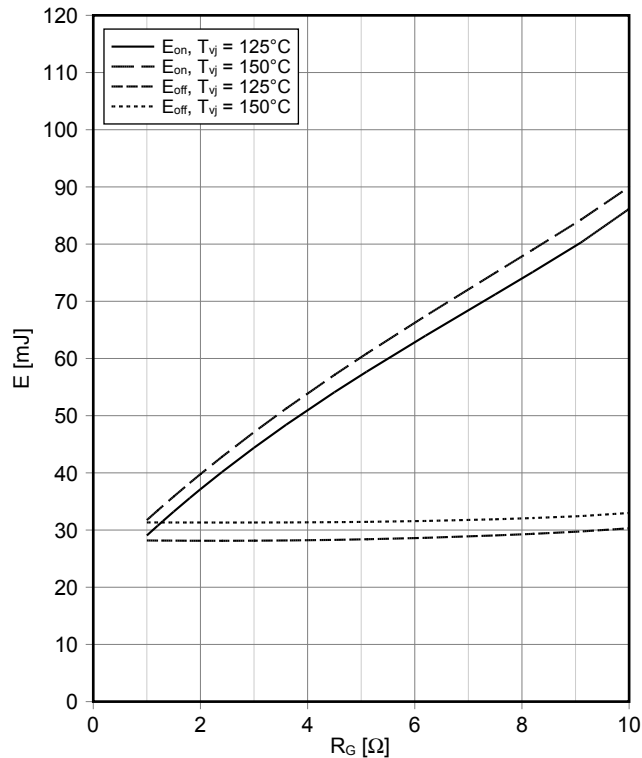
**Schaltverluste IGBT, Wechselrichter (typisch)**  
**switching losses IGBT, Inverter (typical)**

$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Gon} = 1 \Omega$ ,  $R_{Goff} = 1 \Omega$ ,  $V_{CE} = 600 \text{ V}$



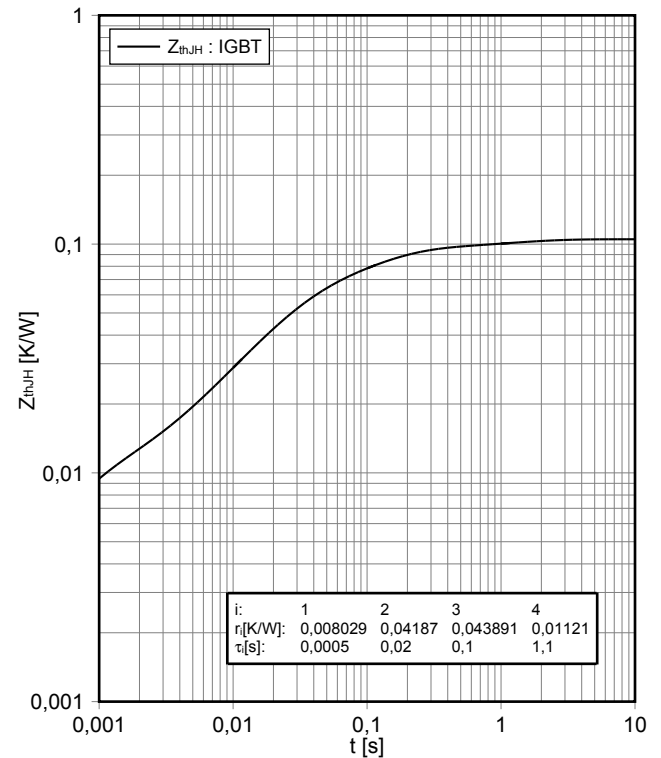
## Schaltverluste IGBT, Wechselrichter (typisch) switching losses IGBT, Inverter (typical)

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $I_C = 300 \text{ A}$ ,  $V_{CE} = 600 \text{ V}$



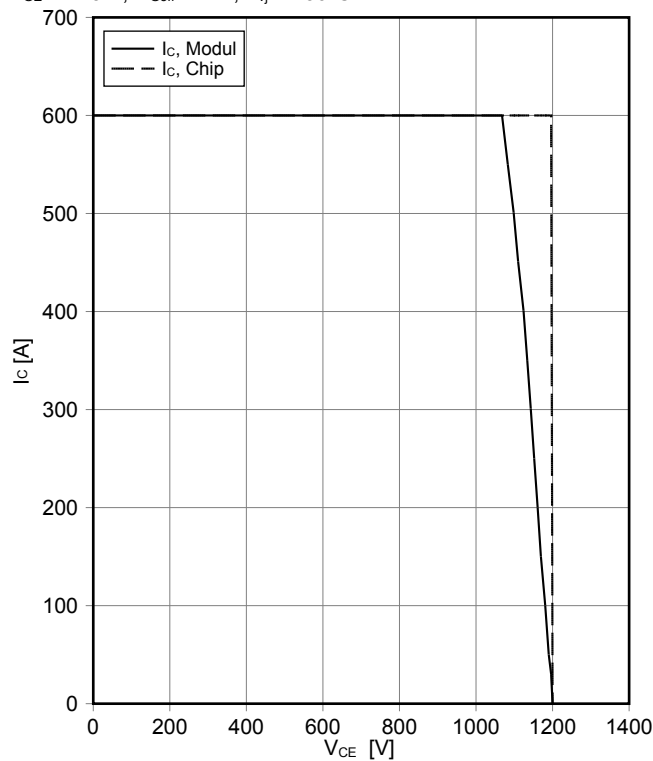
## Transienter Wärmewiderstand IGBT, Wechselrichter transient thermal impedance IGBT, Inverter

$Z_{thJH} = f(t)$



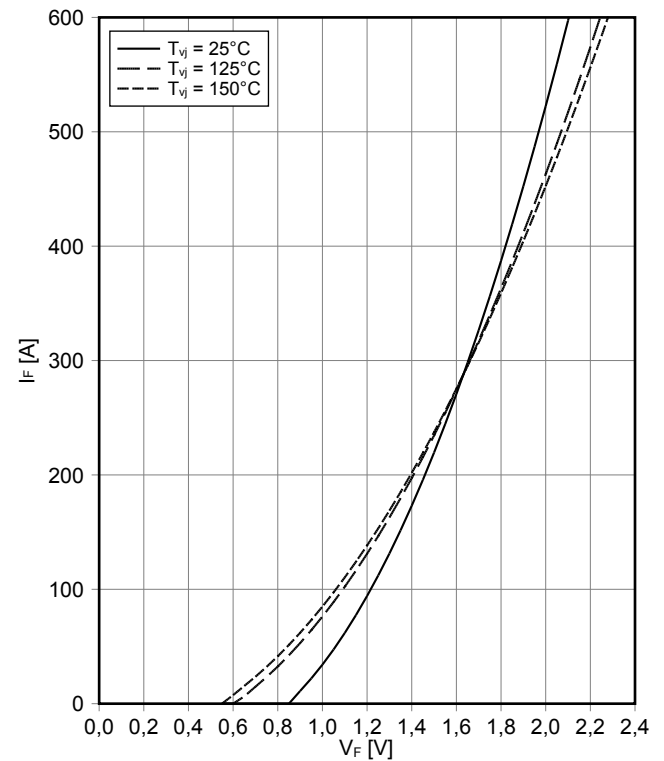
## Sicherer Rückwärts-Arbeitsbereich IGBT, Wechselrichter (RBSOA) reverse bias safe operating area IGBT, Inverter (RBSOA)

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Goff} = 1 \Omega$ ,  $T_{vj} = 150^\circ\text{C}$



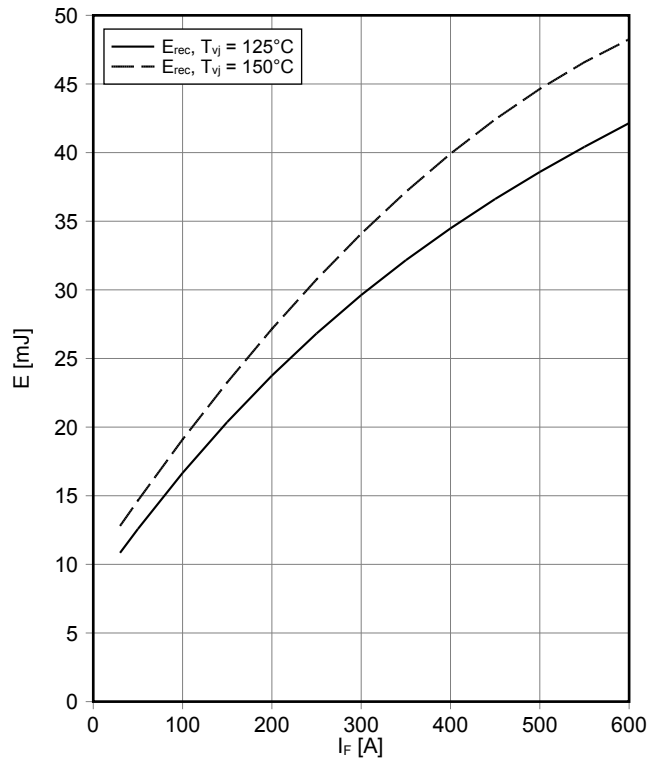
## Durchlasskennlinie der Diode, Wechselrichter (typisch) forward characteristic of Diode, Inverter (typical)

$I_F = f(V_F)$



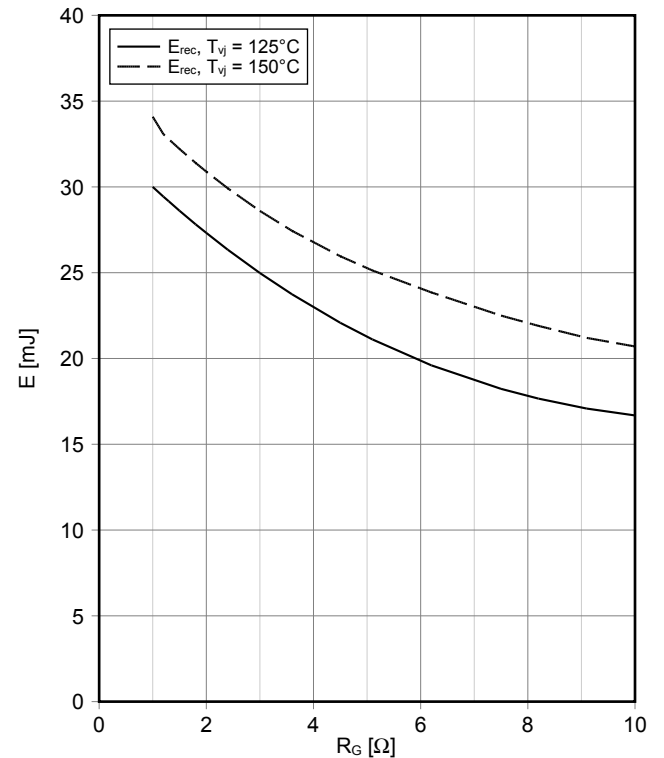
## Schaltverluste Diode, Wechselrichter (typisch) switching losses Diode, Inverter (typical)

$E_{rec} = f(I_F)$   
 $R_{Gon} = 1 \Omega$ ,  $V_{CE} = 600 V$



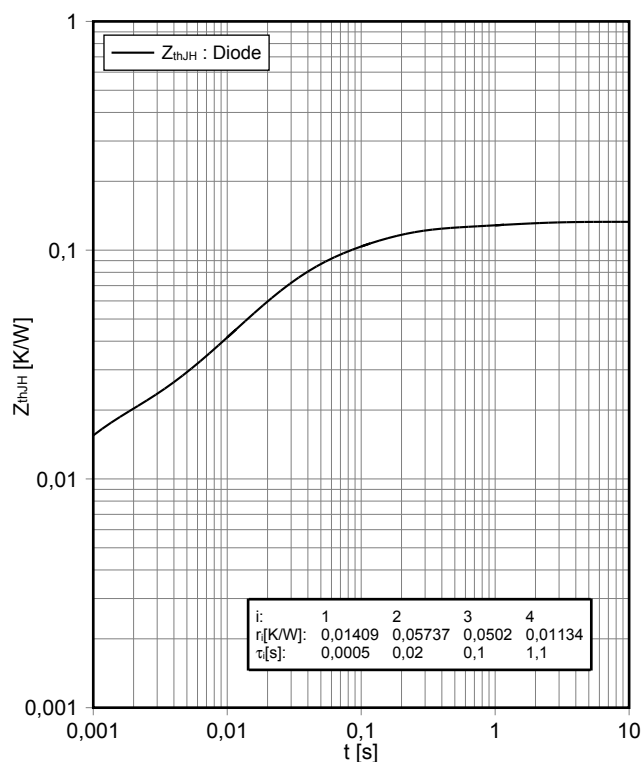
## Schaltverluste Diode, Wechselrichter (typisch) switching losses Diode, Inverter (typical)

$E_{rec} = f(R_G)$   
 $I_F = 300 A$ ,  $V_{CE} = 600 V$



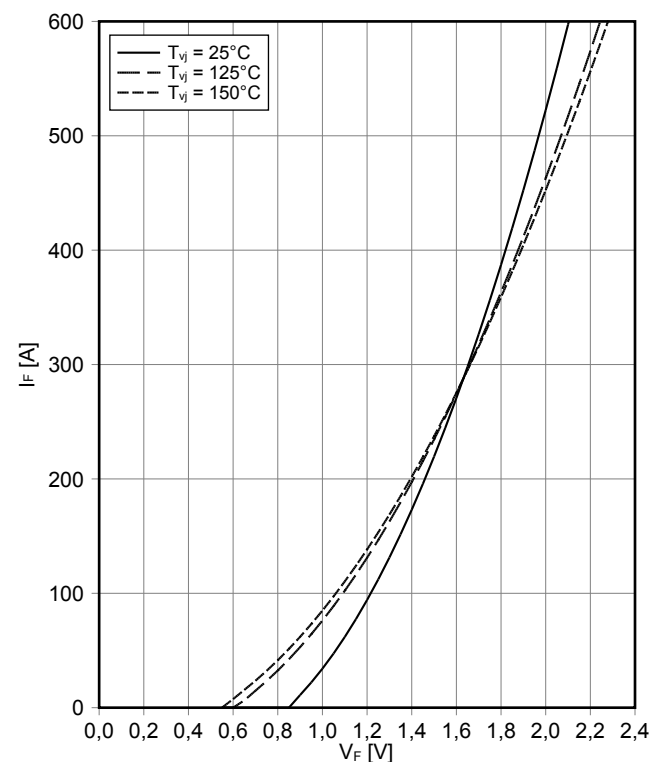
## Transienter Wärmewiderstand Diode, Wechselrichter transient thermal impedance Diode, Inverter

$Z_{thJH} = f(t)$

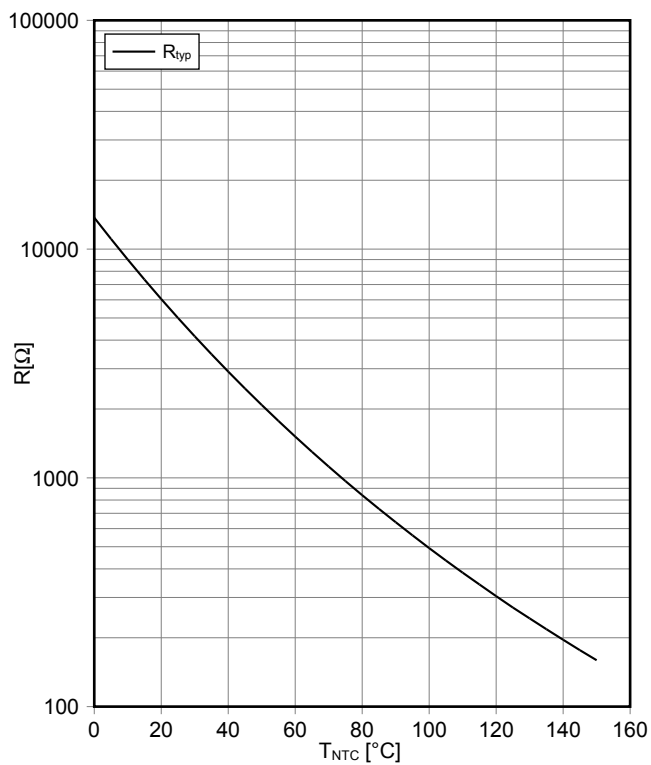


## Durchlasskennlinie der Diode, 3-Level (typisch) forward characteristic of Diode, 3-Level (typical)

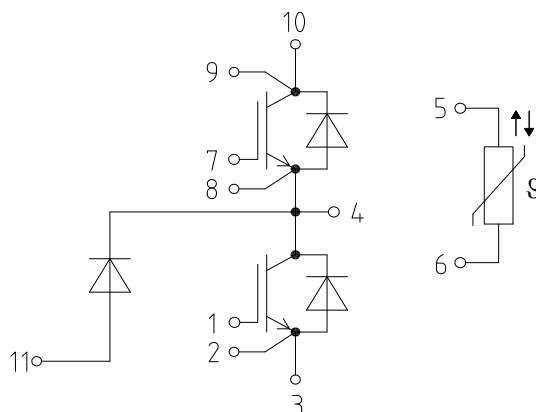
$I_F = f(V_F)$



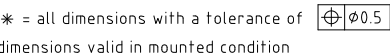
NTC-Widerstand-Temperaturkennlinie (typisch)  
 NTC-Thermistor-temperature characteristic (typical)  
 $R = f(T)$



## Gehäuseabmessungen / Package outlines



## Gehäuseabmessungen / Package outlines



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